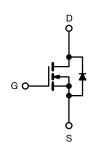
Vishay Siliconix

Power MOSFET





N-Channel MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	V _{GS} = 10 V	4.4			
Q _g (Max.) (nC)	18				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	8.9				
Configuration	Single				

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- · For automatic insertion
- End stackable
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION				
Package	HVMDIP			
Lead (Pb)-free	IRFDC20PbF			

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	V	
Gate-source voltage			V_{GS}	± 20	V	
Continuous drain current	V _{GS} at -10 V	T _A = 25 °C	I _D	0.32	А	
Continuous drain current		T _A = 100 °C		0.20		
Pulsed drain current ^a			I _{DM}	2.6		
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy b			E _{AS}	50	mJ	
Repetitive avalanche current a			I _{AR}	0.32	А	
Repetitive avalanche energy ^a			E _{AR}	0.10	mJ	
Maximum power dissipation	ximum power dissipation $T_A = 25 ^{\circ}C$		P _D	1.0	W	
Peak diode recovery dv/dt ^c			dV/dt	3.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	- 55 to + 150		
Soldering rRecommendations (peak temperature) ^d	For 10 s			300 ^d	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 54 \,^{\circ}\text{mH}$, $R_g = 25 \,^{\circ}\Omega$, $I_{AS} = 1.3 \,^{\circ}\Lambda$ (see fig. 12)
- c. $I_{SD} \le 4.4 \text{ A}$, $dI/dt \le 90 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$
- d. 1.6 mm from case



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.88	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	25 250	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 0.19 A ^b	-	-	4.4	Ω
Forward Transconductance	g _{fs}	$V_{DS} = 50 \text{ V}, I_{D} = 1.3 \text{ A}^{b}$		1.4	-	-	S
Dynamic				L	ı	ı	
Input Capacitance	C _{iss}		V 0 V	-	350	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	48	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	f = 1.0 MHz, see fig. 5		8.6	-	
Total Gate Charge	Qg			-	-	18	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 2.0 \text{ A}, V_{DS} = 360 \text{ V},$ see fig.6 and 13 ^b	-	-	3.0	
Gate-Drain Charge	Q _{gd}	1	goo ng.o ana 10	-	-	8.9	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 300 \text{ V}, I_D = 2.0 \text{ A},$ $R_g = 18 \Omega, R_D = 150 \Omega,$ see fig. 10^b		-	10	-	- ns
Rise Time	t _r			-	23	-	
Turn-Off Delay Time	t _{d(off)}			-	30	-	
Fall Time	t _f			-	25	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	1	nH
Internal Source Inductance	L _S			-	6.0	1	ПП
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	0.32	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	2.6	
Body Diode Voltage	V_{SD}	$T_{J} = 25 ^{\circ}\text{C}, I_{S} = 0.32 \text{A}, V_{GS} = 0 V^{b}$		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C I-	- 2 0 A dl/dt - 100 A/usb	-	290	580	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 2.0 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^b$		-	0.67	1.3	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

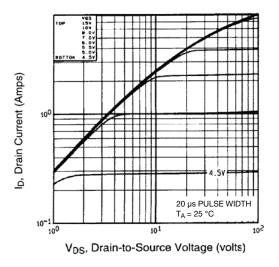


Fig. 1 - Typical Output Characteristics, T_A = 25 °C

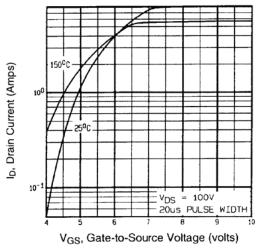


Fig. 3 - Typical Transfer Characteristics

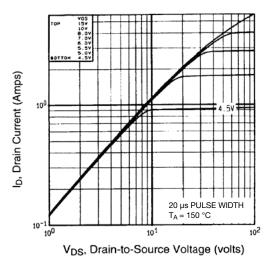


Fig. 2 - Typical Output Characteristics, T_A = 150 °C

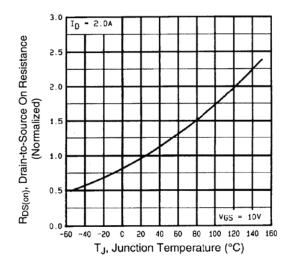


Fig. 4 - Normalized On-Resistance vs. Temperature



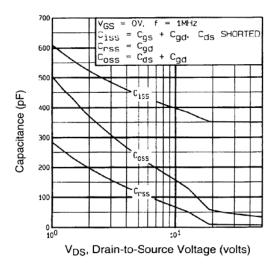


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

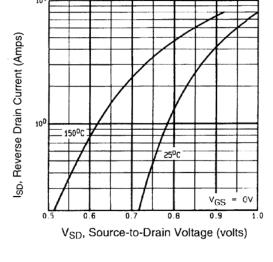


Fig. 7 - Typical Source-Drain Diode Forward Voltage

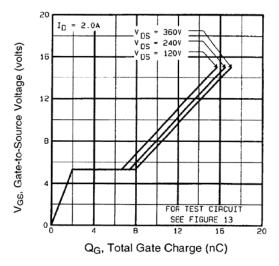


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

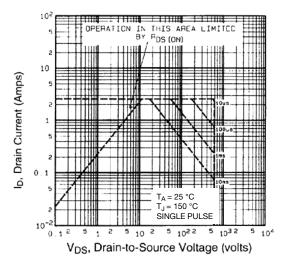


Fig. 8 - Maximum Safe Operating Area



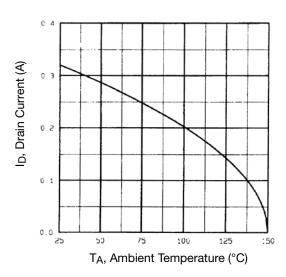


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

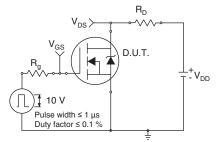


Fig. 10a - Switching Time Test Circuit

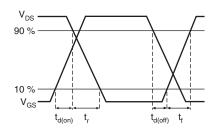


Fig. 10b - Switching Time Waveforms

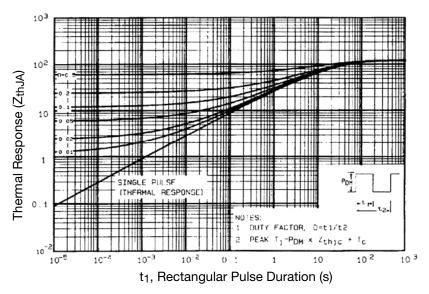


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



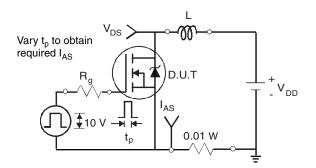


Fig. 12a - Unclamped Inductive Test Circuit

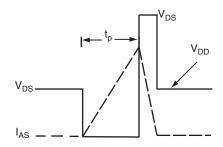


Fig. 12b - Unclamped Inductive Waveforms

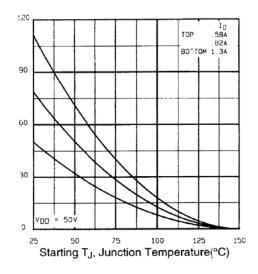


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

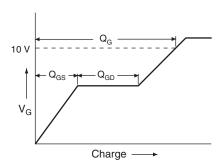


Fig. 13a - Basic Gate Charge Waveform

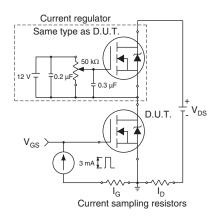
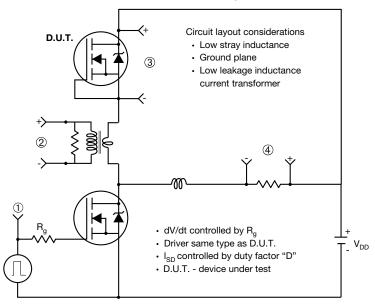


Fig. 13b - Gate Charge Test Circuit



S21-0886-Rev. D, 30-Aug-2021

Peak Diode Recovery dV/dt Test Circuit



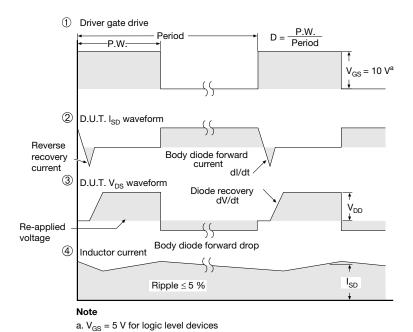
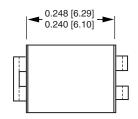


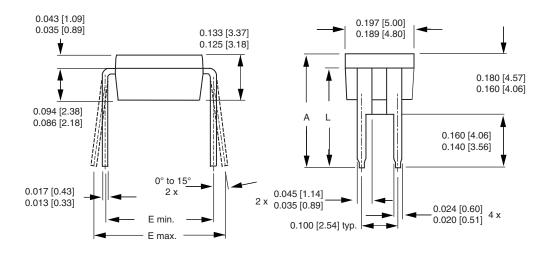
Fig. 14 - For N-Channel

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HVM DIP (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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